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PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yasutaka Nakazawa	12/11/2014
Takayuki Cho	12/12/2014
Shunsuke Koshioka	12/11/2014
Takahiro Sato	12/11/2014
Naoya Sakamoto	12/11/2014
Shunpei Yamazaki	12/10/2014

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE, ATSUGI-SHI
City:	KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14549916

CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: apsi@fr.com DAVID B. HARDY **Correspondent Name:**

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ATTORNEY DOCKET NUMBER:	12732-1381001
NAME OF SUBMITTER:	KRISTI A. HOLMLUND
SIGNATURE:	/Kristi A. Holmlund/
DATE SIGNED:	01/21/2015

Total Attachments: 4

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ASSIGNMENT

For valuable consideration, We, Yasutaka NAKAZAWA of Tochigi, Tochigi, Japan, Takayuki CHO of Tochigi, Tochigi, Japan, Shunsuke KOSHIOKA of Tochigi, Tochigi, Japan, Takahiro SATO of Tochigi, Tochigi, Japan, Naoya SAKAMOTO of Tochigi, Tochigi, Japan and Shunpei YAMAZAKI of Setagaya, Tokyo, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a Japanese corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME, filed November 21, 2014, and assigned U.S. Serial Number 14/549,916, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature	Yasutaka NAKAZAWA
Name:	Yasutaka NAKAZAWA
Date:	12/11/2014
Signature	Takayuki CHO
Name:	Takayuki CHO
Date:	12/12/2014

Signature	Shunsake KUSHIOM
Name:	Shunsuke KOSHIOKA
Date:	12/11 /2014
Signature	Takahiro SATO
Name:	Takahiro SATO
Date:	12/11/2014
Signature Name: Date:	Naoya SAKAMOTO Naoya SAKAMOTO 12/11/2014
Signature	
Name:	Shunpei YAMAZAKI
Date:	

ASSIGNMENT

For valuable consideration, We, Yasutaka NAKAZAWA of Tochigi, Tochigi, Japan, Takayuki CHO of Tochigi, Tochigi, Japan, Shunsuke KOSHIOKA of Tochigi, Tochigi, Japan, Takahiro SATO of Tochigi, Tochigi, Japan, Naoya SAKAMOTO of Tochigi, Tochigi, Japan and Shunpei YAMAZAKI of Setagaya, Tokyo, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a Japanese corporation having a place of business at:

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Signature	
Name:	Yasutaka NAKAZAWA
Date:	
Signature	
Name:	Takayuki CHO
Date:	

Signature	
Name:	Shunsuke KOSHIOKA
Date:	
Signature	
Name:	Takahiro SATO
Date:	
Signature	
Name:	Naoya SAKAMOTO
Date:	
Signature	Shiper Gazzle
Name:	Shunpei YAMAZAKI
Date:	14/0/2014